



Course on:  
Cryostats for accelerator superconducting devices

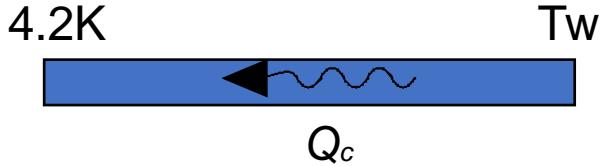
# Exercises

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# Thermal conductivity integrals (conductance) for some materials [W/m]

$$Q_c = \frac{A}{L} \cdot \int_{4.2K}^{T_w} k(T) dT$$

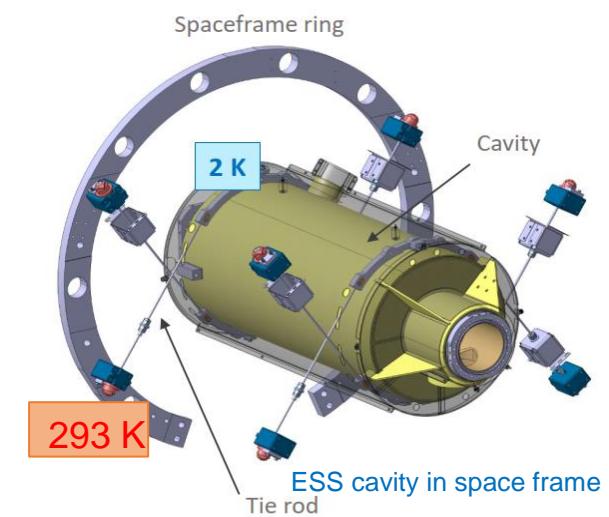


<i>Highest T (Lowest T = 4.2 K)</i>	20 K	80 K	290 K
OFHC Copper	11000	60'600	152'000
DHP Copper	395	5'890	46'100
Aluminium 1100	2740	23'300	72'100
Aluminium 2024	160	2'420	22'900
Titanium (Ti-6Al-4V)	170	1'193	1'363
Stainless steel	16,3	349	3'060
Typical Glass-fiber/Epoxy Composite G-10	2	18	153

# 1. Conduction in supports

- A. Calculate conduction heat loads for the tie rods suspension system:
  - Rod diameter = 6 mm ( $A = 28 \text{ mm}^2$ )
  - Rod length ( $L$ ) = 500 mm
  - Materials: st.steel (304L) or Ti grade 5 (Ti-6Al-4V)
- B. Calculate conduction heat loads with an intermediate heat intercept at 80 K:
  - Calculate optimal position along the length for Ti grade 5 (Ti-6Al-4V)
  - Calculate heat loads
- A. Conduction (integrals from tables or calculation from Cryostat Toolbox):

$$\dot{Q}_{2K} = \frac{A}{L} \int_{2K}^{293K} k_{st,st}(T) dT = 28/500 \times 2.97 = 166 \text{ mW} \quad \dot{Q}_{2K} = \frac{A}{L} \int_{2K}^{293K} k_{Ti}(T) dT = 28/500 \times 1.36 = 76 \text{ mW}$$



- B. Calculate optimal position means minimizing total plug power:
  - $C_{80K}$ : 16 W/W (30% Carnot)
  - $C_{2K}$ : 990 W/W (15% Carnot)

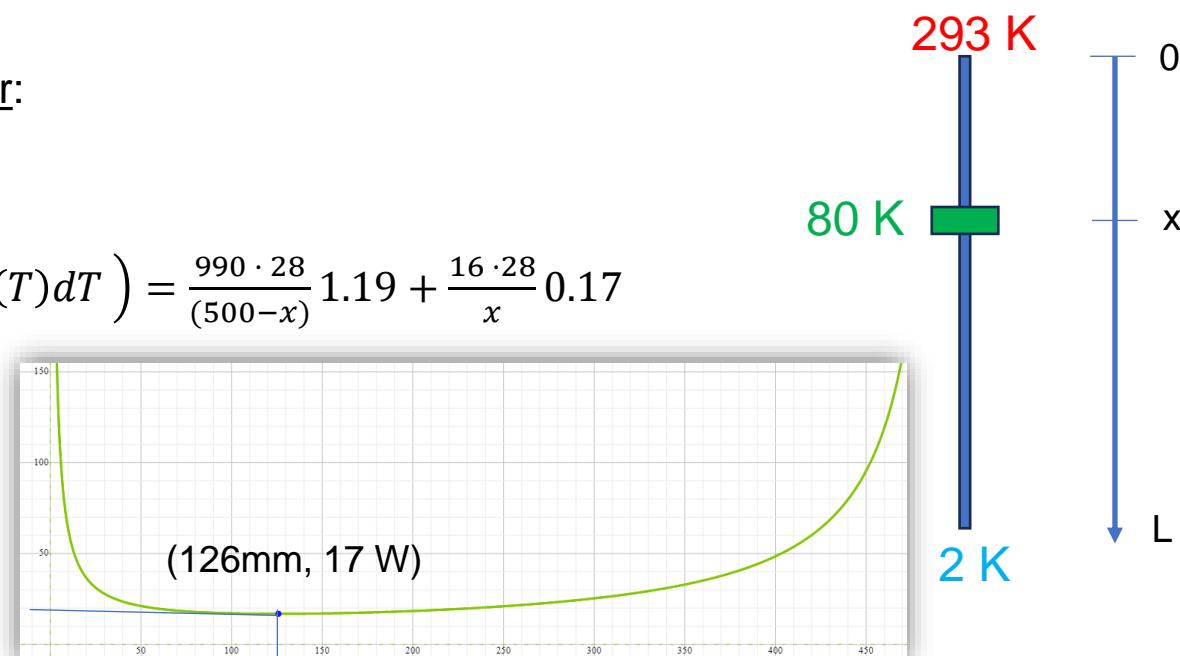
$$W_{tot} = W_{2K} + W_{80K} = C_{2K} \left( \frac{A}{(L-x)} \int_{2K}^{80K} k_{Ti}(T) dT \right) + C_{80K} \left( \frac{A}{x} \int_{80K}^{293K} k_{Ti}(T) dT \right) = \frac{990 \cdot 28}{(500-x)} 1.19 + \frac{16 \cdot 28}{x} 0.17$$

$$\frac{d}{dx} \left( \frac{32'986}{(500-x)} + \frac{76}{x} \right) = \frac{32'986}{(500-x)^2} - \frac{76}{x^2} = 0$$

yields  $\xrightarrow{} x = 126 \text{ mm}; W_{tot} = 17 \text{ W}$

$$\dot{Q}_{80K} = 264 \text{ mW}$$

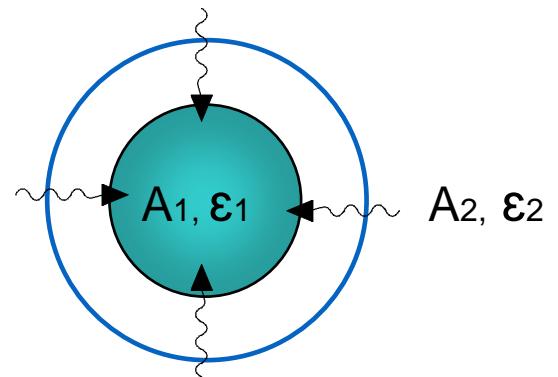
$$\dot{Q}_{2K} = 13 \text{ mW}$$



## 2. Calculate thermal radiation

- Thermal radiation HL for a 1-m cryostat unit length
  - Vacuum vessel diameter: 1m ( $A_2 = \pi \times 1 = 3.14 \text{ m}^2$ )
  - Cold mass diameter: 0.5 m ( $A_1 = \pi \times 0.5 = 1.57 \text{ m}^2$ )
  - $T_1$  cold mass: 2 K
  - $T_2$  vac.vessel: 293 K
  - $\epsilon_1 = 0.12$  (st.steel, mec.polished, 2 K)
  - $\epsilon_2 = 0.2$  (low carbon.steel, mec.polished, 293 K)
- $q_{1-2} = 63.5 \text{ W (41.6 W/m}^2\text{)}$

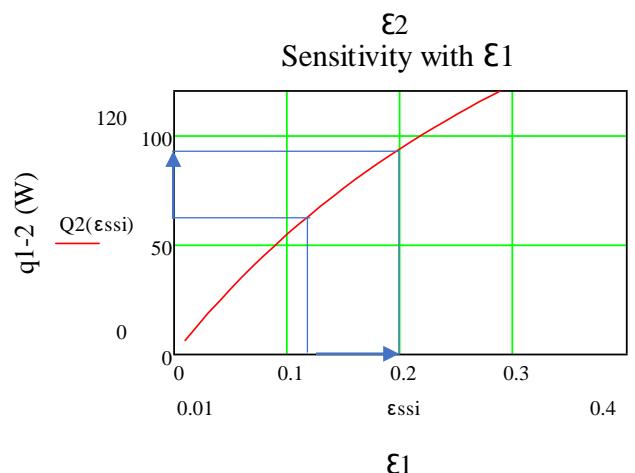
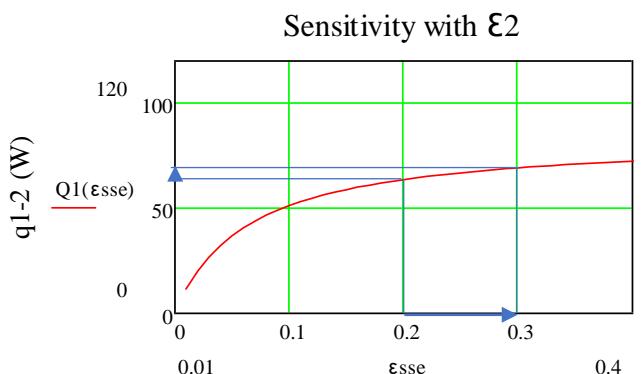
$$q_{1-2} = \frac{\sigma A_1 (T_1^4 - T_2^4)}{\frac{1}{\epsilon_1} + \frac{A_1}{A_2} \left( \frac{1}{\epsilon_2} - 1 \right)}$$



Sensitivity wrt  $\epsilon$  uncertainties:

- $\epsilon_1 = 0.18$  (+50%),  $\epsilon_2 = 0.20$  →  $q_{1-2} = 87 \text{ W (+37%)}$
- $\epsilon_1 = 0.12$ ,  $\epsilon_2 = 0.30$  (+50%) →  $q_{1-2} = 69 \text{ W (+9%)}$
- $\epsilon_1 = 0.18$  (+50%),  $\epsilon_2 = 0.30$  (+50%) →  $q_{1-2} = 98 \text{ W (+54%)}$
- Note: assuming black bodies ( $\epsilon_1 = \epsilon_2 = 1$ ) →  $q_{1-2} = 656 \text{ W ! (x10!)}$

→ Knowing  $\epsilon_1$  is 4 times more important than  $\epsilon_2$

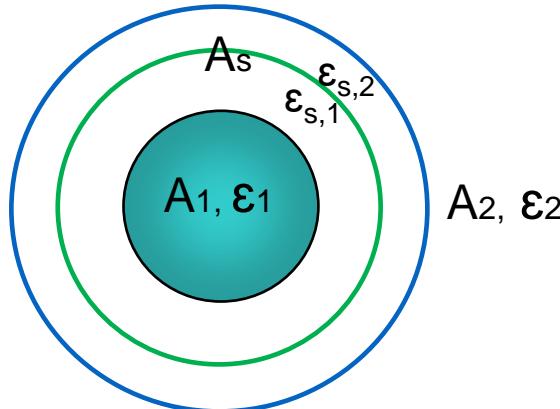


The CERN logo consists of a circular emblem with the word "CERN" written in the center.

## 3. Thermal radiation with a floating shield

- Floating AI shield

$$q1 - 2 = \frac{\sigma(T1^4 - T2^4)}{\underbrace{\frac{1 - \varepsilon_1}{\varepsilon_1 A_1} + \frac{1}{A_1 F_1 S}}_{\text{A1 to S gap}} + \underbrace{\frac{1 - \varepsilon_S, 1}{\varepsilon_S, 1 A_S} + \frac{1 - \varepsilon_S, 2}{\varepsilon_S, 2 A_S} + \frac{1}{A_S F_S 2}}_{\text{S to A2 gap}} + \frac{1 - \varepsilon_2}{\varepsilon_2 A_2}}$$



## Floating AI shield:

- Thermal shield diameter:  $0.75 \text{ m}$  ( $A_s = \pi \times 0.75 = 2.35 \text{ m}^2$ )
  - $F_{1s} = 1$ ;  $F_{2s} = 1$
  - $T_s = 80 \text{ K}$  (first guess)
  - $\varepsilon_{s,1} = \varepsilon_{s,2} = 0.1$  (Aluminum, mec.polished, 80 K)

$\rightarrow q_{1-2} = q_{1-s} = q_{s-2} = 28.5 \text{ W}$

$\rightarrow T_s = 260 \text{ K} \rightarrow \text{increase } \varepsilon_{s,1} = \varepsilon_{s,2} (0.15?) \text{ and recalculate}$

$\rightarrow q_{1-2} = q_{1-s} = q_{s-2} = 35.4 \text{ W}$  (to be compared to 63.5 W without shield)

$\rightarrow q_{1-s} = 35.4 \text{ W}$  ( $22.5 \text{ W/m}^2$ ),  $q_{s-2} = 35.4 \text{ W}$  ( $15 \text{ W/m}^2$ )

$$q_1 - 2 = \frac{1}{\varepsilon_1}$$

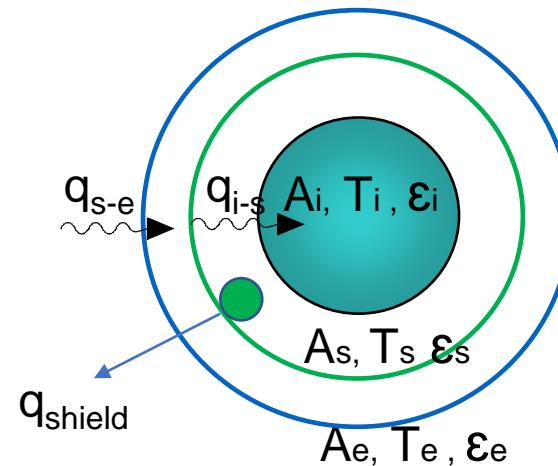
$$q1 - 2 = \frac{\sigma(T1^4 - T2^4)}{\frac{1 - \varepsilon 1}{\varepsilon 1 A1} + \frac{1}{A1} + \frac{1 - \varepsilon s}{\varepsilon s As} + \frac{1 - \varepsilon s}{\varepsilon s As} + \frac{1}{As} + \frac{1 - \varepsilon 2}{\varepsilon 2 A2}}$$

→ 1 floating shield reduces to almost  $\frac{1}{2}$  the radiation to the low T  
(close to flat plates approximation for this geometry)

## 4. Thermal radiation with an actively cooled shield

- Actively cooled intermediate shield
  - $T_s = 80 \text{ K}$  (now an input)
  - $\varepsilon_s = 0.1$  (Aluminum, mec.polished, 80 K)
  - Radiation between vessel and shield:
- $q_{s-e} = 76 \text{ W (32 W/m}^2\text{)}$

$$q_{s-e} = \frac{\sigma A_s (T_s^4 - T_e^4)}{\frac{1}{\varepsilon_s} + \frac{A_s}{A_e} \left( \frac{1}{\varepsilon_e} - 1 \right)}$$



- Radiation between shield (80 K) and helium vessel (2 K):
  - $\varepsilon_i = 0.12$  (st.steel, mec.polished, 2 K)
- $q_{i-s} = 0.26 \text{ W (0.16 W/m}^2\text{)}$  (x 136 times less than with floating shield !)
- Radiation heat extraction from thermal shield (not to be forgotten!):
- $q_{\text{shield}} = q_{s-e} - q_{i-s} = 75.74 \text{ W}$

$$q_{i-s} = \frac{\sigma A_i (T_i^4 - T_s^4)}{\frac{1}{\varepsilon_i} + \frac{A_i}{A_s} \left( \frac{1}{\varepsilon_s} - 1 \right)}$$

→ Actively cooled shield at  $T \sim 80 \text{ K}$  drastically reduces radiation to the lowest T and “deviates” heat load to the shield (*but do not forget to “pay” for its cooling!*)

# 5. Thermal radiation with a floating shield with MLI

- MLI with N reflectors, floating shields
- Radiation between vac.vessel and shield with MLI (based on flat plat approximation):

- $N = 30$
- $T_s = 80 \text{ K}$  (first guess)
- $\varepsilon_e = 0.2$  (low carbon.steel, mec.polished, 293 K)
- $\varepsilon_s = 0.08$  (Aluminium reflector, electrolytical deposition, 80 K)
- $\varepsilon_{av} = \frac{1}{2} (\varepsilon_s + \varepsilon_e)$  (average emissivity)
- $A_{av} = \frac{1}{2} (A_s + A_e)$  (average area)

$$\rightarrow q_{s-e} = 2.7 \text{ W (0.14 W/m}^2\text{)} \text{ (with } T_s = 80 \text{ K)}$$

- Radiation between shield (80 K) and helium vessel (formula between enclosed cylinders):

$$\rightarrow q_{i-s} = 0.23 \text{ W (0.012 W/m}^2\text{)} \text{ (with } T_s = 80 \text{ K)}$$

- Calculate  $T_s$  by *trial and error* (and tune  $\varepsilon_s$ ) to obtain power balance  $q_{s-e} = q_{i-s}$  (floating shield condition)

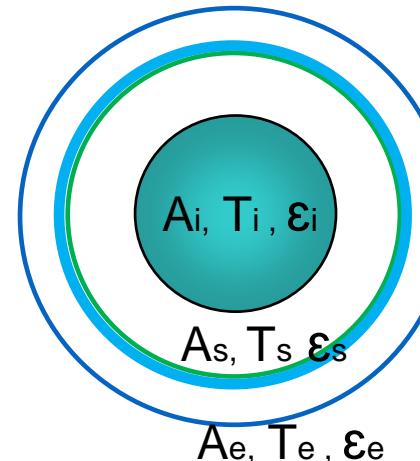
$$\rightarrow T_s = 143 \text{ K}, \rightarrow \varepsilon_s = 0.1$$

$$q_{s-e} = q_{i-s}$$

$$\rightarrow q_{s-e} = 2.6 \text{ W (1.65 W/m}^2\text{)}$$

$$\rightarrow q_{i-s} = 2.6 \text{ W (0.96 W/m}^2\text{)}$$

$$q_{s-e} = \frac{\sigma A_{av} (T_s^4 - T_e^4)}{(N + 1) \left( \frac{2}{\varepsilon_{av}} - 1 \right)}$$



→ MLI (30 layers) reduce the HL to the thermal shield (and cold surface) by a factor x 15 wrt simple shield

## 6. Thermal radiation with an actively cooled shield with MLI

- MLI with N reflectors, actively cooled shield
- Radiation between shield and vac.vessel (flat plat approximation):

$$q_{s-e} = \frac{\sigma A_{av} (T_s^4 - T_e^4)}{(N + 1) \left( \frac{2}{\varepsilon_{av}} - 1 \right)}$$

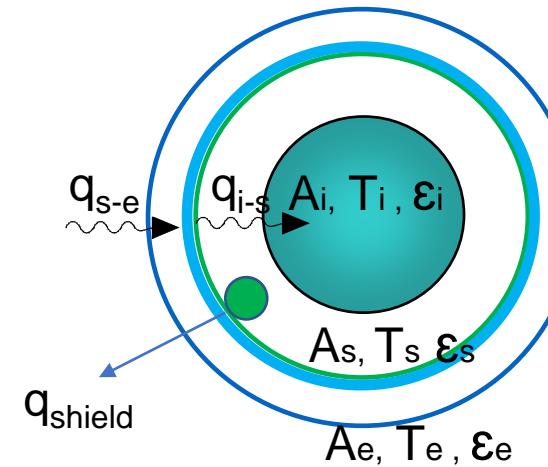
- $N = 30$
  - $T_s = 80 \text{ K}$  (now an input)
  - $\varepsilon_s = 0.08$  (Aluminium reflector, electrolytical deposition, 80 K)
  - $\varepsilon_{av} = \frac{1}{2} (\varepsilon_s + \varepsilon_e)$  (average emissivity)
  - $A_{av} = \frac{1}{2} (A_s + A_e)$  (average area)
- $q_{s-e} = 2.78 \text{ W (1.0 W/m}^2\text{)}$

- Radiation between shield (80 K) and helium vessel (2 K) (formula between enclosed cylinders):

→  $q_{i-s} = 0.23 \text{ W (0.14 W/m}^2\text{)}$  (x10 times less than with floating shield !)

- Radiation heat extraction from thermal shield (not to be forgotten!):

→  $q_{\text{shield}} = q_{s-e} - q_{i-s} = 2.55 \text{ W}$

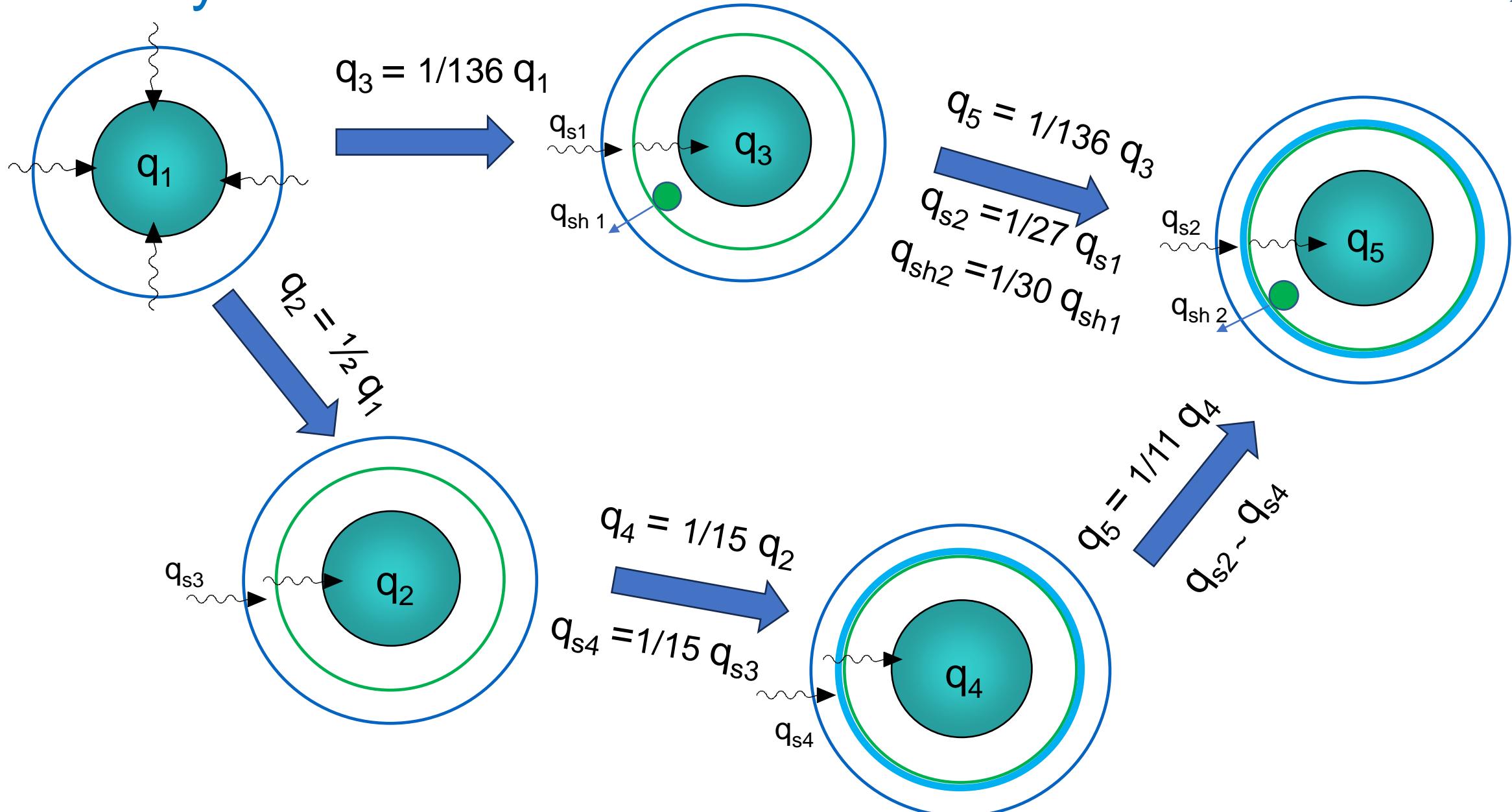


$$q_{i-s} = \frac{\sigma A_s (T_s^4 - T_i^4)}{\frac{1}{\varepsilon_s} + \frac{A_s}{A_i} \left( \frac{1}{\varepsilon_i} - 1 \right)}$$

→ Actively cooled shield at ~80 K drastically reduces Heat Load to the lowest T  
 → MLI reduces the Heat Loads to the shield

An actively cooled shield at ~80 K with MLI is standard practice in all helium cryostats!

# Summary



# 7. calculate a thermal shield thickness in an LHC-type cryostat

$$t = \frac{q \cdot L^2}{2 \cdot k \cdot \Delta T_{\max}}$$

- Symmetry: point opposite of cooling line is an isolated tip
- Diameter thermal shield:  $0.75 \text{ m} \rightarrow A_s = \pi \times 0.75 \times 1 = 2.35 \text{ m}^2$
- Take  $\frac{1}{2}$  shield:  $L = \frac{1}{2} \frac{A_s}{1 \text{ m}} = \frac{1}{2} 2.35 \text{ m} = 1.17 \text{ m}$
- Uniform heat deposition (previous exercise):  $q = \frac{q_{\text{shield}}}{A_s} = \frac{2.55 \text{ W}}{2.35 \text{ m}^2} = 1.08 \text{ W/m}^2$   $q_{\text{shield}}$
- Let's set the maximum  $\Delta T_{\max} = 5 \text{ K}$
- Take  $k$  aluminium (Al6061) at  $\sim 80 \text{ K}$ :  $85 \text{ W/(K m)}$
- $t = 1.7 \text{ mm}$**

Remark:

- If thermal shield in Cu alloy (e.g. CuNi70-70) →  $k = 37 \text{ W/(K m)}$  →  $t = 0.74 \text{ mm}$  ...too thin sheets for mech. stability

